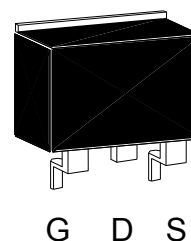


N-Channel Enhancement Mode Power MOSFET

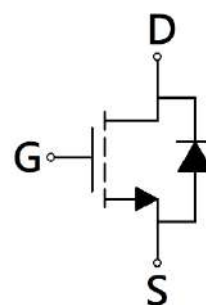
Features:

- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic

TO-263



KWE05N08F3



G : Gate S : Source D : Drain

BV_{DSS}	80V
$I_D @ V_{GS}=10V, T_C=25^{\circ}C$	86A
$I_D @ V_{GS}=10V, T_A=25^{\circ}C$	25A
$R_{DS(ON) typ.} @ V_{GS}=10V, I_D=20A$	3.6m Ω

Ordering Information

Device	Package	Shipping
KWE05N08F3	TO-263 (Pb-free lead plating and halogen-free package)	800 pcs / Tape & Reel

Absolute Maximum Ratings (T_A=25°C)

Parameter		Symbol	Limits	Unit
Drain-Source Voltage		V _{DS}	80	V
Gate-Source Voltage		V _{GS}	±30	
Continuous Drain Current @ V _{GS} =10V, T _C =25°C (silicon limit) *a		I _D	94	A
Continuous Drain Current @ V _{GS} =10V, T _C =25°C (package limit) *a			86	
Continuous Drain Current @ V _{GS} =10V, T _C =100°C *a			60	
Continuous Drain Current @ V _{GS} =10V, T _A =25°C *b			25	
Continuous Drain Current @ V _{GS} =10V, T _A =70°C *b			20	
Pulsed Drain Current *c			I _{DM}	
Continuous Body Diode Forward Current @ T _C =25°C *a		I _S	86	mJ
Avalanche Current @ L=0.1mH		I _{AS}	60	
Avalanche Energy @ L=0.5mH		E _{AS}	306	
Total Power Dissipation	T _C =25°C *a	P _D	104	W
	T _C =100°C *a		42	
	T _A =25°C *b		7.4	
	T _A =70°C *b		4.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C

Thermal Data

Parameter	Symbol	Steady State	Unit
Thermal Resistance, Junction-to-case	R _{θJC}	1.2	°C/W
Thermal Resistance, Junction-to-ambient *b	R _{θJA}	17	

Note:

- *a. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- *b. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2 oz. copper, in a still air environment with T_A=25°C. The power dissipation P_D is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- *c. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and low duty cycles to keep initial T_J=25°C.

Electrical Characteristics (T_A=25°C, unless otherwise specified)

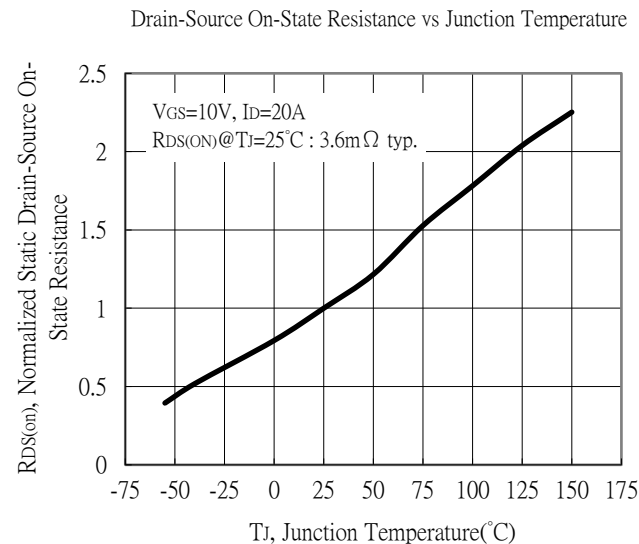
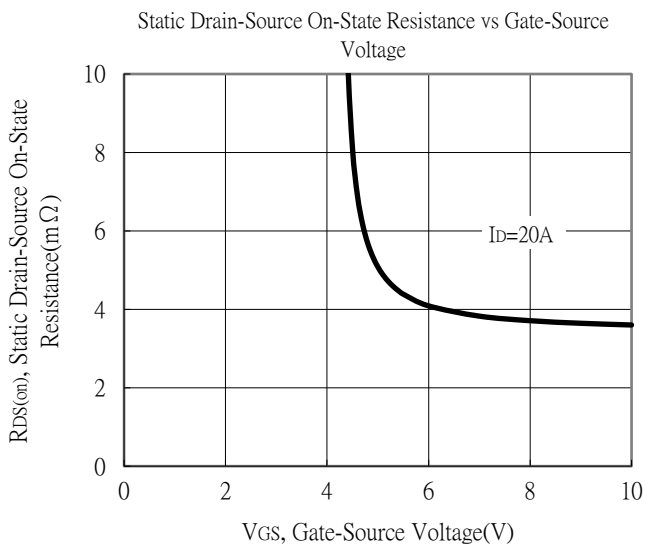
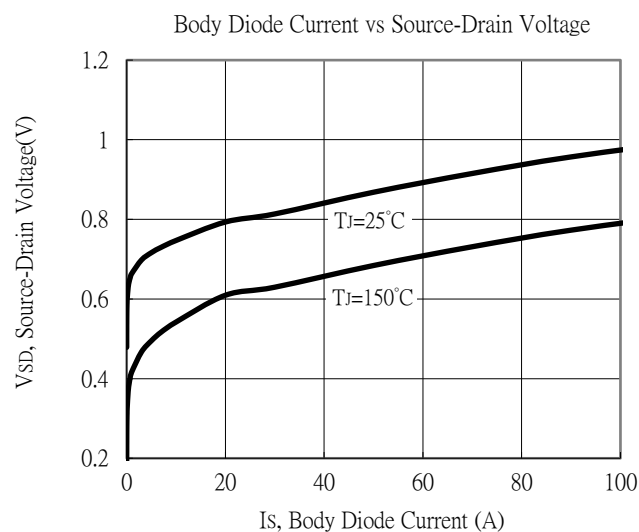
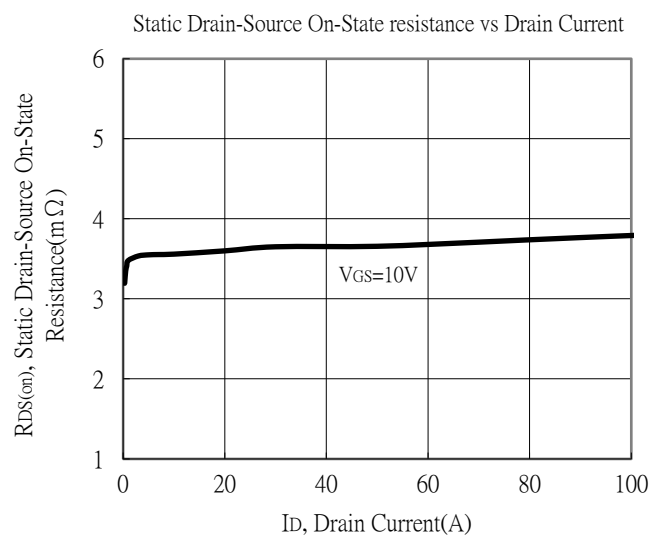
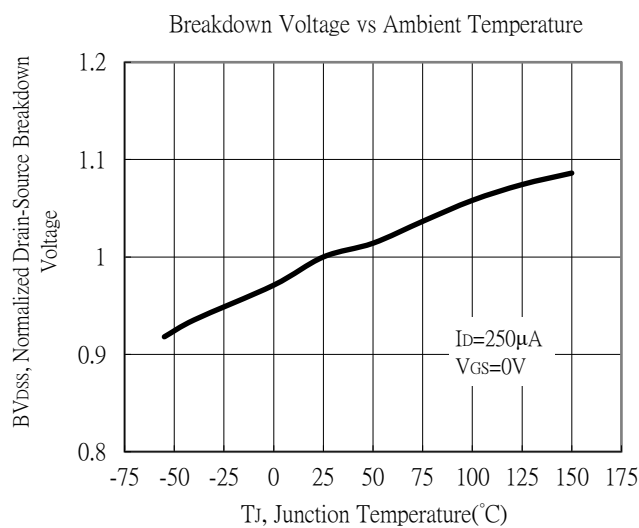
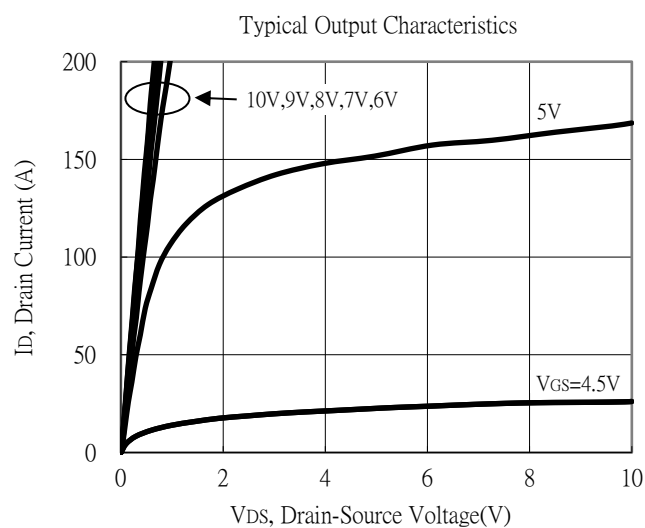
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	80	-	-	V	V _{GS} =0V, I _D =250μA
V _{GS(th)}	2	-	4		V _{DS} =V _{GS} , I _D =250μA
G _{FS}	-	42	-	S	V _{DS} =10V, I _D =20A
I _{GSS}	-	-	±100	nA	V _{GS} =±30V, V _{DS} =0V
I _{DSS}	-	-	1	μA	V _{DS} =64V, V _{GS} =0V
R _{DS(ON)}	-	3.6	5.2	mΩ	V _{GS} =10V, I _D =20A
Dynamic					
C _{iss}	-	6800	-	pF	V _{DS} =40V, V _{GS} =0V, f=1MHz
C _{oss}	-	745	-		
C _{rss}	-	310	-		
R _g	-	0.9	-	Ω	f=1MHz
Q _g *1, 2	-	133	-	nC	V _{DS} =40V, I _D =20A, V _{GS} =10V
Q _{gs} *1, 2	-	36	-		
Q _{gd} *1, 2	-	48	-		
t _{d(ON)} *1, 2	-	50	-	ns	V _{DS} =40V, I _D =20A, V _{GS} =10V, R _{GS} =1 Ω
t _r *1, 2	-	45	-		
t _{d(OFF)} *1, 2	-	88	-		
t _f *1, 2	-	27	-		
Source-Drain Diode					
V _{SD} *1	-	0.76	1.2	V	I _S =20A, V _{GS} =0V
t _{rr}	-	47	-	ns	I _F =20A, dI _F /dt=100A/μs
Q _{rr}	-	74	-	nC	

Note:

*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

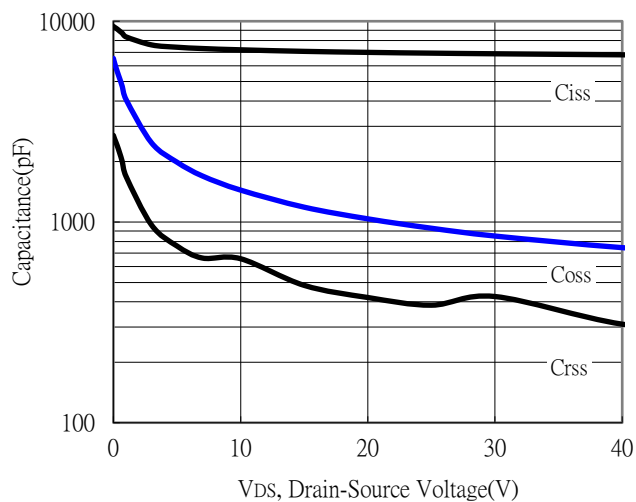
*2. Independent of operating temperature

Typical Characteristics

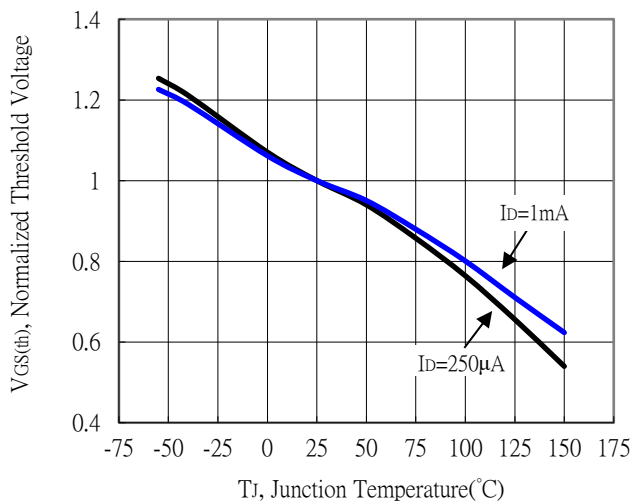


Typical Characteristics (Cont.)

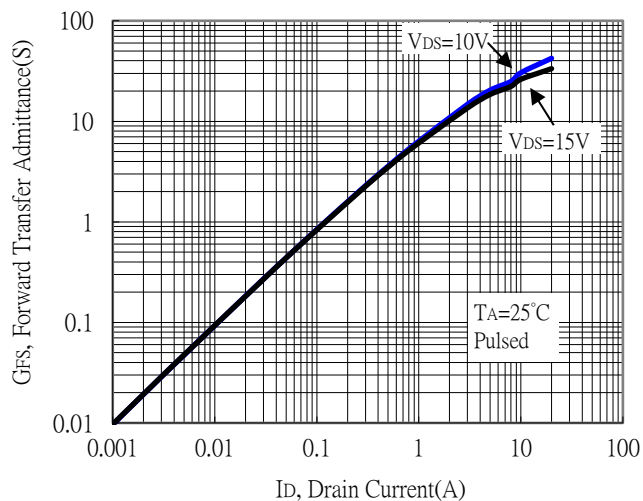
Capacitance vs Drain-to-Source Voltage



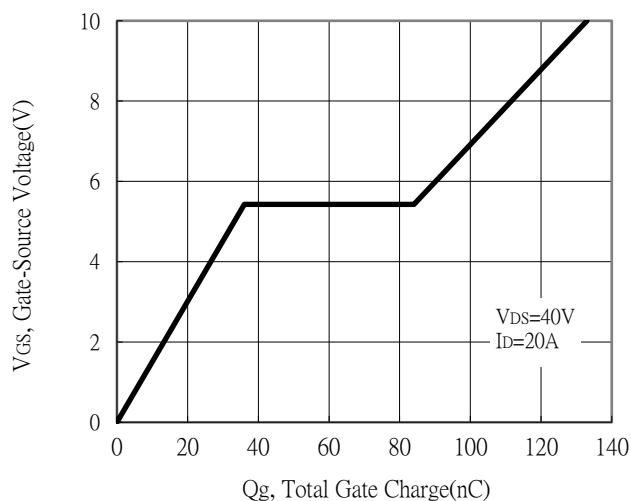
Threshold Voltage vs Junction Temperature



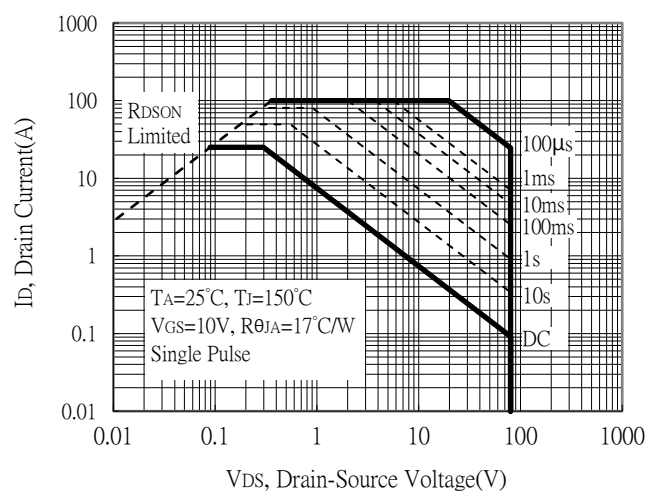
Forward Transfer Admittance vs Drain Current



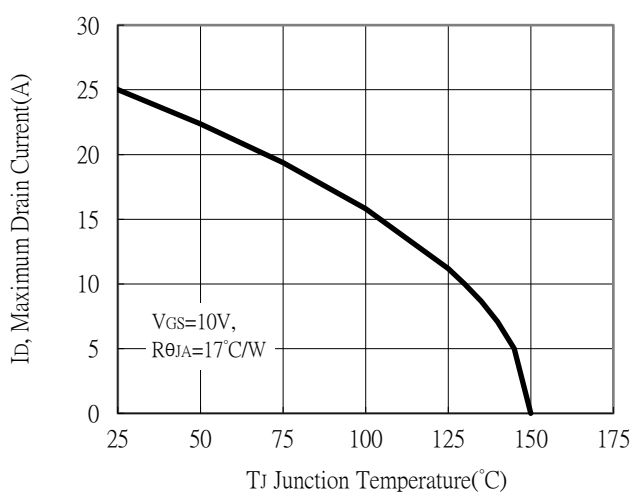
Gate Charge Characteristics



Maximum Safe Operating Area

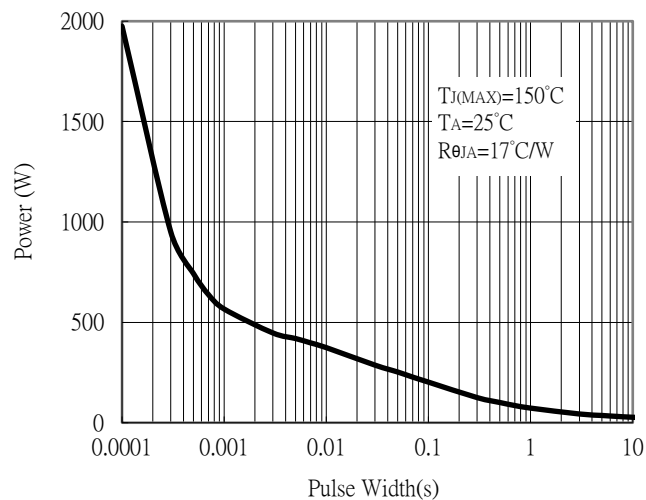


Maximum Drain Current vs Junction Temperature

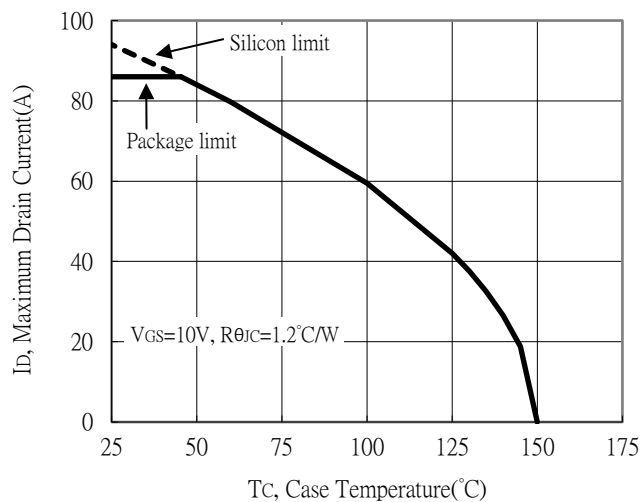


Typical Characteristics (Cont.)

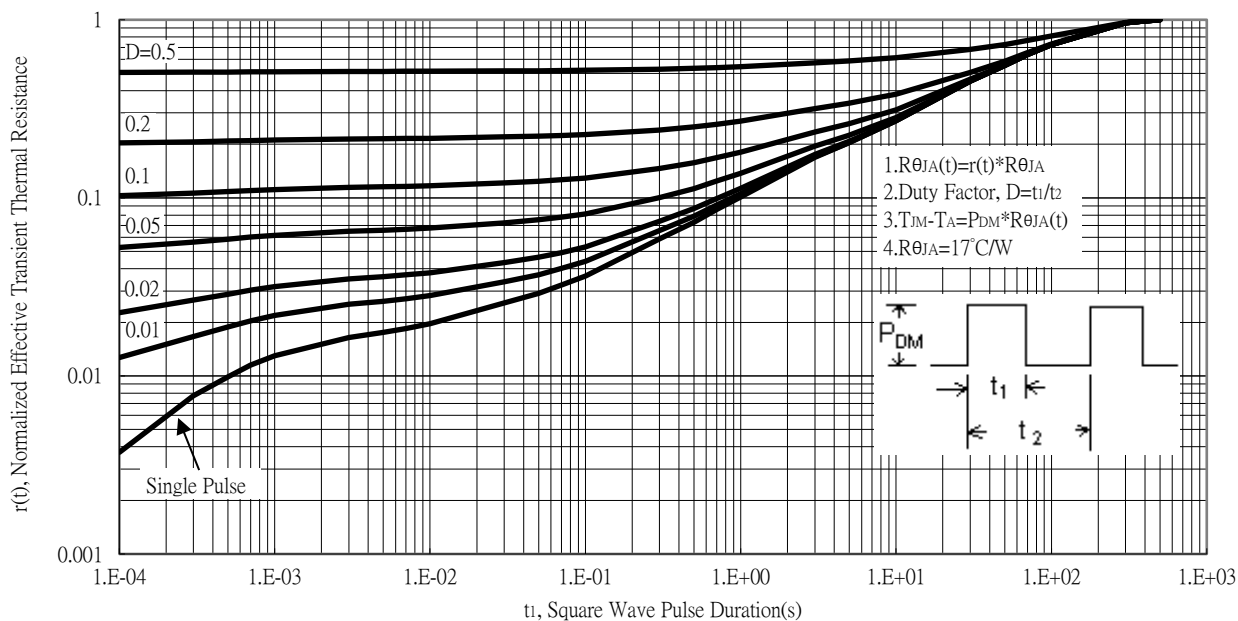
Single Pulse Power Rating, Junction to Ambient



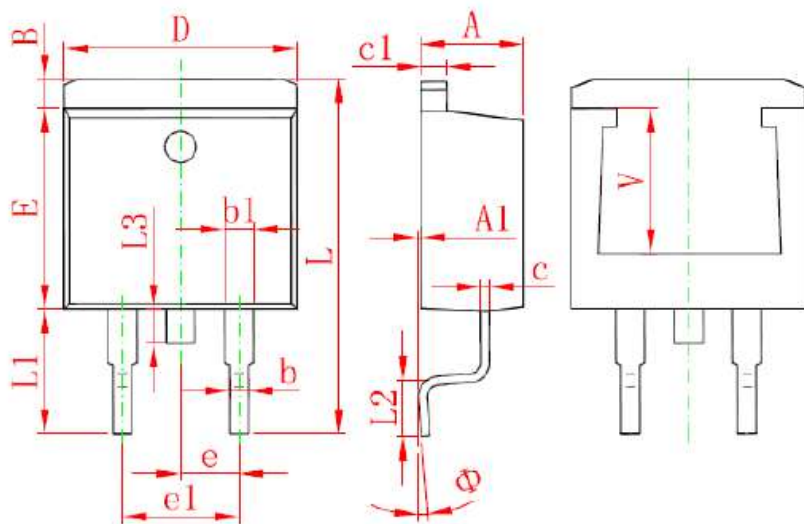
Maximum Drain Current vs Case Temperature



Transient Thermal Response Curves

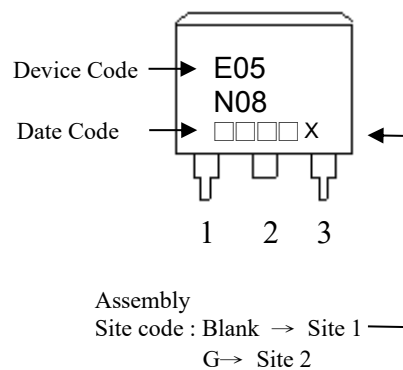


TO-263 Dimension



3-Lead Plastic Surface Mounted Package
 Package Code : F3

Marking :



Style : Pin 1.Gate 2.Drain
 3.Source

Date Code(counting from left to right) :

1st code: year code, the last digit of Christian year

2nd code : month code, Jan→A, Feb→B, Mar→C, Apr→D

May→E, Jun→F, Jul→G, Aug→H, Sep→J,

Oct→K, Nov→L, Dec→M

3rd and 4th codes : production serial number, 01~99

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.240	4.670	0.167	0.184	e	2.540	TYP	0.100	TYP
A1	0.000	0.150	0.000	0.006	e1	4.980	5.180	0.196	0.204
B	1.120	1.420	0.044	0.056	L	14.610	15.880	0.575	0.625
b	0.700	0.910	0.028	0.036	L1	4.430	5.500	0.174	0.217
b1	1.170	1.700	0.046	0.067	L2	1.780	2.790	0.070	0.110
c	0.310	0.600	0.012	0.024	L3	1.300	1.700	0.051	0.067
c1	1.150	1.400	0.045	0.055	Φ	0°	8°	0°	8°
D	9.960	10.360	0.392	0.408	V	5.500	REF	0.217	REF
E	8.500	9.020	0.335	0.355					